

READ ONLY MEMORY

## 20K Cartridge ROM

### FEATURES

- Mask Programmable Storage Providing 2048 x 10 Bit Words
- 16 Bit On-Chip Address Latch
- Memory Map Circuitry to Place the 2K ROM Page Within a 65K Memory Area
- 16 Bit Tri-State Bus with Higher 6 Bits Driven to Zero During Read Operations

### CIRCUIT REQUIREMENTS

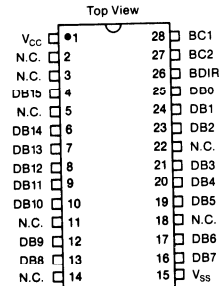
The RO-3-9504 operates as the program memory for systems using a CP1610 microprocessor. It is configured as 2048 x 10 bit words and contains several features which reduce the device count in a practical microprocessor application.

### DESCRIPTION

From initialization, the RO-3-9504 waits for the first address code i.e., BAR. For this address code and all subsequent address sequences, the 9504 reads the 16-bit external bus and latches the value into its address register.

The 9504 contains a programmable memory map location for its own 2K page, and if a valid address is detected, the particular address location will transfer its contents to the chip output buffers. If the control code following the address cycle was a READ, the 9504 will output the 10 bits of addressed data and drive a logic zero on the top six bits of the bus.

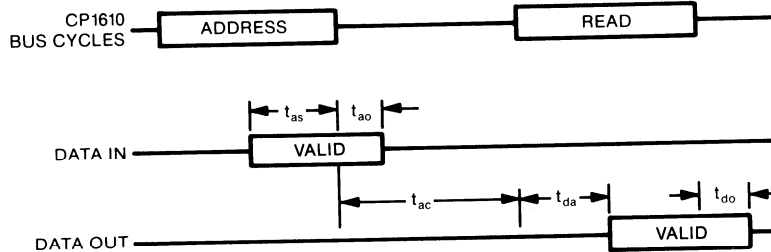
### PIN CONFIGURATION 28 LEAD DUAL IN LINE



### INPUT CONTROL SIGNALS

BDIR	BC1	BC2	Equivalent Signal	Decoded Function
0	0	0	NACT	No ACTION, D0-D15 = High Impedance
0	0	1	IAB	No Action
0	1	0	ADAR	Address Data to Address Register, D0-D15 = High Impedance
0	1	1	DTB (READ)	Data To Bus, D0-D15 = Input
1	0	0	BAR	Bus to Address Register
1	0	1	DWS	No Action
1	1	0	DW	No Action
1	1	1	INTAK	INTerrupt AcKnowledge

### TIMING DIAGRAM



**ELECTRICAL CHARACTERISTICS****Maximum Ratings\***

Temperature Under Bias .....	0° C to 100° C
Storage Temperature .....	-55° C to +150° C
All Input or Output Voltages with Respect to $V_{SS}$ .....	-0.2V to +9.0V
$V_{CC}$ with Respect to $V_{SS}$ .....	-0.2V to +9.0V

**Standard Conditions** (unless otherwise stated):

$T_A$ = 0° C to +55° C
$V_{CC}$ = +4.85V - +5.15V
$V_{SS}$ = 0.0V

\* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied—operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

**DC CHARACTERISTICS**

Characteristics	Sym	Min	Max	Units	Conditions
<b>Inputs</b>					
Input Logic Low	$V_{IL}$	0	0.7	V	$V_{IN} = 0V$ to $V_{CC}$ $V_{IN} = 0V$
Input Logic High	$V_{IH}$	2.4	$V_{CC}$	V	
Input Leakage	$I_{IL}$	—	5	$\mu A$	
Capacitance	—	—	10	pf	
<b>CPU BUS Outputs</b>					
Output Logic Low	$V_{OL}$	0	0.5	V	$I_{OL} = 1.5mA$ +150pf $I_{OH} = -200\mu A$
Output Logic High	$V_{OH}$	2.4	$V_{CC}$	V	
<b>Supply Current</b>					
$V_{CC}$ Supply	$I_{CC}$	—	120	mA	25° C

**AC CHARACTERISTICS**

Characteristics	Sym	Min	Max	Units	Conditions
<b>Inputs</b>					
Address Set Up	$t_{as}$	400	—	ns	
Address Overlap	$t_{ao}$	65	—	ns	
<b>CPU BUS Outputs</b>					
Turn ON Delay	$t_{da}$	—	350	ns	
Turn OFF Delay	$t_{do}$	85	—	ns	
Access Time	$t_{ac}$	—	1.5	$\mu s$	

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